### **POWER MOSFET**

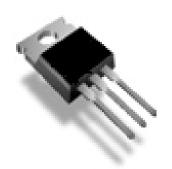
**IRF830** 

**Advance Information** 

#### **Description**

The Bay Linear MOSFET's provide the designers with the best combination of fast switching, ruggedized device design, low 0n-resistance and low cost-effectiveness.

The TO-220 is offered in a 3-pin is universally preferred for all commercial-industrial applications at power dissipation level to approximately to 50 watts. Also, available in a  $D^2$  surface mount power package with a power dissipation up to 2 Watts



#### **Features**

- Dynamic dv/dt Rating
- Repetitive Avalanche Rated
- Fast Switching
- Ease of Paralleling
- Simple Drive Requirements

$$V_{DSS} = 500V$$

$$R_{DS (ON)} = 1.5 \Omega$$

$$I_D = 4.5A$$

## **Ordering Information**

Device	Package	Temp.
IRL830T	TO-220	0 to 150°C
IRL830S	$TO-263 (D^2)$	0 to 150°C

## **Absolute Maximum Rating**

	Parameter	Max	Unit	
$I_D @ T_C = 25$ °C	Continuous Drain Current, V <sub>GS</sub> @10V	4.5	A	
$I_D @ T_C = 100$ °C	Continuous Drain Current, V <sub>GS</sub> @10V	2.9		
$I_{DM}$	Pulsed Drain Current (1)	18		
P <sub>D</sub> @ T <sub>C</sub> =25°C	Power Dissipation	74	W	
	Linear Derating Factor	0.59	W/OC	
	Linear Derating Factor (PCB Mount, D <sup>2</sup> ) (1)	0.025	W/°C	
V <sub>GS</sub> Gate-to- Source Voltage		±20	V	
$\mathbf{E}_{\mathbf{AS}}$	Single Pulse Avalanche Energy (2)	280	mJ	
$I_{AR}$	Avalanche Current (1)	4.5	A	
$\mathbf{E}_{\mathbf{A}\mathbf{R}}$	Repetitive Avalanche Energy (1)	7.4	mJ	
dv/dt	Peak Diode Recovery dv/dt (3)	3.5	V/ns	
$T_{J}, T_{STG}$	Junction & Storage Temperature Range	-55 to $+150$	•C	
	Soldering Temperature, for 10 seconds	300 (1.6mm from case)		

#### **Thermal Resistance**

	Parameter	Min	Тур	Max	Units
$R_{ m  heta JC}$	Junction-to Case	-	-	1.7	
$R_{\theta CS}$	Case-to-Sink, Flat, Greased Surface (TO-220)	-	0.50		°C/W
$R_{\theta JA}$	Junction-to Ambient (PCB Mount, D <sup>2</sup> )			40	C/W
$R_{\theta JA}$	Junction-to Ambient	-	-	62	

# Electrical Characteristics ( $T_C = 25$ °C unless otherwise specified)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
V <sub>(BR)DSS</sub>	Drain-to-source Breakdown Voltage	$V_{GS} = 0V, I_D = 250\mu A$	500			V
$\begin{array}{c} V_{(BR)DSS} / \\ \Delta T_J \end{array}$	Breakdown Voltage Temperature Coefficient	Reference to 25°C, $I_D = 1 \text{mA}$	-	0.61	-	V/°C
$I_{D(ON)}$	On-State Drain Current (note 2)	$V_{GS} > I_{D(ON)} \times R_{DS(ON)} Max$			4.5	A
$R_{DS(ON)} \\$	Static Drain-to-Source On-Resistance	$V_{GS} = 10V, I_D = 2.7A$ (note 4)			1.5	Ω
V <sub>GS(TH)</sub>	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250 \mu A$	2.0	-	4.0	V
$\mathbf{g}_{\mathrm{fs}}$	Forward Transconductance	$V_{DS} = 50V, I_D = 2.7A$	2.5	-	-	S
$I_{DSS}$	Drain-to-Source Leakage Current	$V_{DS} = 500V, V_{GS} = 0V$ $V_{DS} = 400V, V_{GS} = 0V,$ $T_{C} = 125^{\circ}C$	-	-	25 250	μА
$I_{GSS}$	Gate-to-Source Forward Leakage	$V_{GS} = 20V$	_	_	100	nA
IGSS	Gate-to-Source Reverse Leakage	$V_G = -20V$	_	_	-100	
$\mathbf{Q}_{\mathrm{g}}$	Total Gate Charge	$I_D = 3.1A$	-	-	38	
$\mathbf{Q}_{\mathbf{q}\mathbf{s}}$	Gate-to-Source Charge	$V_{DS} = 400V$	-	-	5.0	nC
$\mathbf{Q}_{\mathbf{gd}}$	Gate-to-Drain ("Miller") Charge	$V_{GS} = 10V \text{ (note 4)}$			22	li C
$t_{d\ (on)}$	Turn-On Delay Time	$V_{DD} = 250V$	-	8.2	-	
T <sub>r</sub>	Rise Time	$I_D = 3.1.1A$	-	16	-	ns
t <sub>d (off)</sub>	Turn -Off Delay Time	$R_G = 12\Omega$	-	42	-	11.5
$T_f$	Fall Time	$R_D = 79\Omega \text{ (note 4)}$	-	16	-	
$\mathbf{L}_{\mathbf{D}}$	Internal Drain Inductance	Between lead 6mm (0.25in.) from package and center or die	-	4.5	-	nН
$L_{S}$	Internal Source Inductance	contact	-	7.5	-	
Ciss	Input Capacitance	$V_{GS} = 0V$	-	610	-	
Coss	Output Capacitance	$V_{\rm DS} = 25 V$	-	160		pF
$C_{rss}$	Reverse Transfer Capacitance	F = 1.0MHZ	-	68	-	

# **Source-Drain Rating Characteristics**

Symbol	Parameter	Conditions	Min	Тур	Max	Units
$I_S$	Continuous Source Current (Body Diode)	MOSFET symbol showing the integral reverse p-n junction diode.	-	-	4.5	A
$I_{SM}$	Pulsed Source Current (Body Diode) (Note 1)		-	-	18	A
$V_{SD}$	Diode Forward Voltage (note 4)	$T_J = 25^{\circ} C_I_S = 2.5 A, V_{GS} = DV$	-	-	1.6	V
$\mathbf{t_{rr}}$	Reverse Recovery Time	$T_J = 25^{\circ} C, I_F = 2.1A$	-	320	640	ns
$\mathbf{Q}_{\mathbf{rr}}$	Reverse Recovery Charge	di/dt=100A/µs (Note 4)	-	1.0	2.0	μC
ton	Forward Turn-On Time	Intrinsic turn-on time is negligible	(turn-on	is domin	ated by (	$L_S+L_D$ )

Notes: 1. Repetitive Rating; pulse width limited by max. junction temperature.

<sup>2.</sup>  $V_{DD} = 50V$ , starting Tj = 25°C, L = 24 mH R<sub>G</sub> = 25 $\Omega$ , I<sub>AS</sub> = 4.5A

<sup>3.</sup>  $I_{SD} \le 4.5 A$ ,  $di/dt \le 75 A/\mu s$ ,  $V_{DD} \le V_{(BR)DSS}$ ,  $T_j \le 150 ^{\circ} C$ 

<sup>4.</sup> Pulse with  $\leq 300 \mu s$ ; duty cycle  $\leq 2\%$ 

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